



NC265



No Clean Liquid Flux

Features:

- Rosin and Resin-Free
- Halide-Free
- Broad Process Window
- Low Post Process Residues
- Fast Wetting for SN100C® and SAC alloys
- Lead-Free and Tin-Lead Compatible

Description:

NC265 is an alcohol-based no-clean liquid flux formulated to offer a very wide process window for lead-free and tin-lead wave soldering operations. NC265 offers faster wetting for SN100C® and SAC alloys than previously formulated fluxes and is compatible with a broad range of lead-free and tin-lead solder alloys. NC265 offers low post-process residues and has proven to reduce preventative maintenance requirements for spray fluxing applications. NC265 is designed to be a no-clean, non-visible residue flux, which can be cleaned if critical to the product application.

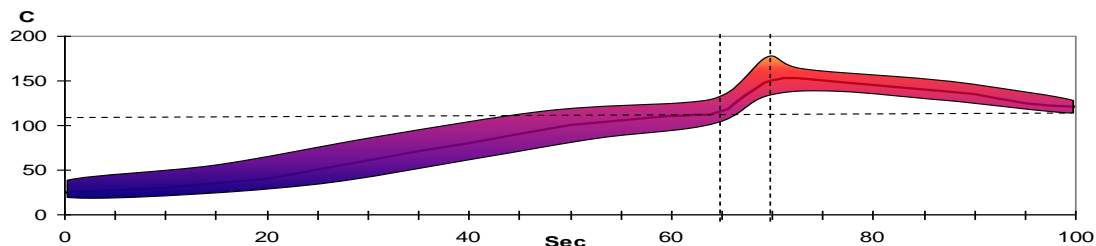
Application:

- NC265 is formulated for application via spray, foam, brush, mist, or dip. For spraying, NC265 is ready to use directly from its container, no thinning required. When spray fluxing, it is imperative that proper flux coverage and uniformity be achieved and maintained. A dry flux coating of 500-1500 micrograms per square inch is recommended as a starting point.
- When nitrogen sealed wave solder equipment is used, it is generally necessary to apply slightly more flux than normal as a result of excess drying due to the extended length of the equipment.
- When foaming, air stones should be supplied with compressed air, free of oil and moisture. Adjust foam head to achieve uniform bubble size for optimum coverage. During foaming applications, it is periodically necessary to add AIM's Common Flux Thinner to replace that which is lost due through evaporation.

Process Control:

Because of the low percentage of solids in this flux, control of specific gravity with automated equipment usually is found to be ineffective; therefore, control via titration is necessary. AIM's Titration Kit has proven to be cost-effective, user friendly, quick and accurate. Titration should be carried out at least once an hour for flux foaming operations, or more often if large variances are found.

Thermal Profile:



RATE of RISE 2-3 °C / SEC MAX	PROGRESS THROUGH 66°C - 77°C (150 - 170°F) ≤ 40 SECONDS	PCB TOP SIDE TEMP 87°C - 115°C (190°F - 240°F) JUST BEFORE WAVE	COOLDOWN ≤ 4°C
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Cleaning:

NC265 can be cleaned, if necessary, with saponified water or an appropriate solvent cleaner. Please refer to the AIM No-Clean-Cleaner Matrix for a list of suitable cleaning materials.

Handling:

- NC265 has an unopened shelf life of 1 year when stored at room temperature.
- Do not store near fire or flame.
- Keep away from sunlight as it may degrade product.
- NC265 is shipped ready-to-use, no mixing necessary.
- Do not mix used and unused chemical in the same container.
- Reseal any opened containers.

Safety:

- Use with adequate ventilation and proper personal protective equipment.
- Refer to the accompanying Material Safety Data Sheet for any specific emergency information.
- Do not dispose of any hazardous materials in non-approved containers.

Physical Properties:

Parameter	Value
J-STD-004	ORL0
Visual	Clear, Colorless
Odor	Aromatic (Slightly)
Solids Content	4.05% ± 0.5
Acid Number	35.74 ± 2.13 mg KOH/gr flux

Parameter	Value
Specific Gravity	0.7976 ± 0.0087 (water = 1)
Flash Point	< 10°C
Boiling Point	82°C
pH (1% solution /water)	4.4012 ± 1.0212

Corrosion Testing:

Parameter	Requirements	Results
Copper Mirror (24 hrs @ 25°C, 50%RH)	IPC-TM-650-2.3.32	Low
Halide Test (Silver Chromate)	IPC-TM-650-2.2.33	Pass

Surface Insulation Resistance:

Reference	Property	Pass-Fail Criteria	Results
IPC-TM-650 method 2.6.3.3 85°C / 85% R.H.	Control coupons	>1E+9 Ω at 96 and 168 hrs	3.15E+9 Ω and 3.02E+9 Ω Pass
	Sample coupons – pattern up	>1E+8 Ω at 96 and 168 hrs	3.03E+9 Ω and 2.93E+9 Ω Pass
	Sample coupons – pattern down	>1E+8 Ω at 96 and 168 hrs	4.26E+8 Ω and 6.03E+8 Ω Pass
	Post-test visual inspection	No dendrite growth or corrosion	Pass

Electromigration:

Test	Conditions	Specification	Results
Electromigration Bellcore GR-78 Flux Requirements	65°C/85% R.H. 500 hrs – Control	Rf/Ri > 0.1	7.67E+10 Ω / 5.53E+10 Ω – Pass
	65°C/85% R.H. 500 hrs – Sample	Rf/Ri > 0.1	1.69E+11 Ω / 2.30E+10 Ω – Pass

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 AIM IS ISO9001:2008 CERTIFIED

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В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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